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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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Silicon PNP Triple Diffused

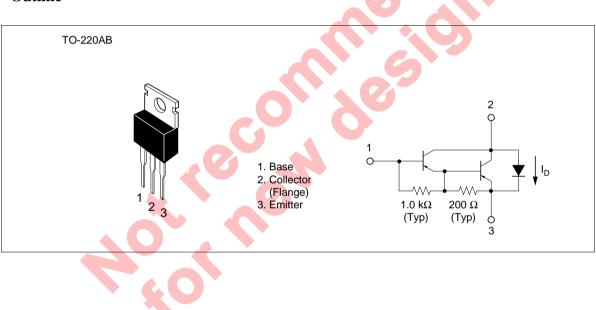


ADE-208-863 (Z) 1st. Edition September 2000

Application

Power switching complementary pair with 2SD1126(K)

Outline



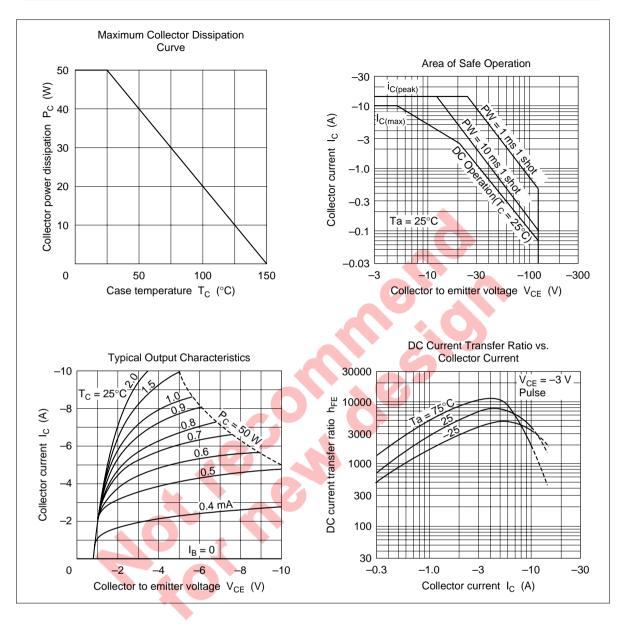
Absolute Maximum Ratings (Ta = 25°C)

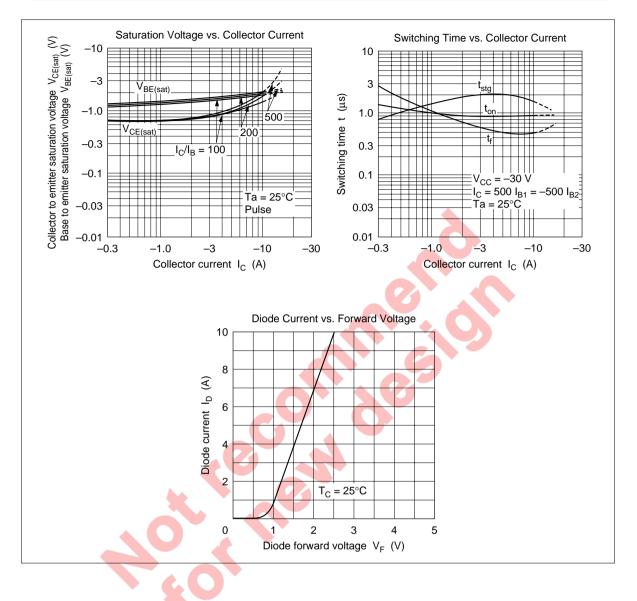
Item	Symbol	Rating	Unit V	
Collector to base voltage	V _{CBO}	-120		
Collector to emitter voltage	V _{CEO}	-120	V	
Emitter to base voltage	V _{EBO}	-7	V	
Collector current	Ι _c	I _c –10		
Collector peak current	I _{C(peak)}	–15	А	
C to E diode forward current	۱ _D *1	10	А	
Collector power dissipation	P _c * ²	50	W	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	
Natary 4 Malus at T 0500				

Electrical Characteristics (Ta = 25°C)

Notes: 1. Value at $T_c = 25^{\circ}C$									
2. $PW \le 1 \text{ ms } 1 \text{ shot}$					5				
						0			
Electrical Characteristics (Ta = 25°C)									
Electrical characteristics $(1a - 25 C)$									
Item	Symbol	Min	Тур	Max	Unit	Test conditions			
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-120	-	6	V	$I_{c} = -25 \text{ mA}, \text{ R}_{\text{BE}} = \infty$			
Emitter to base breakdown voltage	V _{(BR)EBO}	-7	-	_	V	$I_{\rm E} = -200 \text{ mA}, I_{\rm C} = 0$			
Collector cutoff current	Гсво	-	9	-100	μA	$V_{CB} = -120 \text{ V}, I_{E} = 0$			
	I _{CEO}	- (<u> </u>	-10	μA	$V_{CE} = -100 \text{ V}, \text{ R}_{BE} = \infty$			
DC current transfer ratio	h _{FE}	1000	_	20000		$V_{ce} = -3 \text{ V}, \text{ I}_{c} = -5 \text{ A}^{*1}$			
Collector to emitter saturation	$V_{CE(sat)1}$			-1.5	V	$I_{\rm c} = -5$ A, $I_{\rm B} = -10$ mA ^{*1}			
voltage	V _{CE(sat)2}	—		-3.0	V	$I_{\rm c} = -10$ A, $I_{\rm B} = -0.1$ A ^{*1}			
Base to emitter saturation	V _{BE(sat)1}	_	_	-2.0	V	$I_{c} = -5 \text{ A}, I_{B} = -10 \text{ mA}^{*1}$			
voltage	V _{BE(sat)2}	—		-3.5	V	$I_{\rm c} = -10$ A, $I_{\rm B} = -0.1$ A ^{*1}			
C to E diode forward voltage	V _D	—		3.0	V	$I_{\rm D} = 10 \ {\rm A}^{*1}$			
Turn on time	t _{on}	_	0.8	_	μs	$V_{cc} = -30 \text{ V}$			
Turn off time	t _{off}	_	4.0	_	μs	$I_{\rm C} = -5$ A, $I_{\rm B1} = -I_{\rm B2} = -10$ mA			
Note: 1 Pulse test									

Note: 1. Pulse test





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